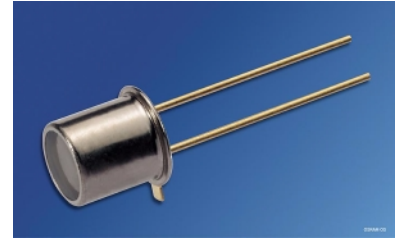


Silizium-PIN-Fotodiode Silicon PIN Photodiode

BPX 65



Wesentliche Merkmale

- Speziell geeignet für Anwendungen im Bereich von 350 nm bis 1100 nm
- BPX 65: Hohe Fotoempfindlichkeit
- Hermetisch dichte Metallbauform (TO-18), geeignet bis 125 °C

Anwendungen

- Schneller optischer Empfänger mit großer Modulationsbandbreite

Features

- Especially suitable for applications from 350 nm to 1100 nm
- BPX 65: high photosensitivity
- Hermetically sealed metal package (TO-18), suitable up to 125 °C

Applications

- Fast optical sensor of high modulation bandwidth

Typ Type	Bestellnummer Ordering Code	Gehäuse Package
BPX 65	Q62702-P27	18 A3 DIN 41870, planes Glasfenster, hermetisch dichtes Gehäuse, Lötspieße im 2.54-mm-Raster (² / ₁₀ "), Anodenkennzeichnung: Nase am Gehäuseboden 18 A3 DIN 41870, flat glass lens, hermetically sealed package, solder tabs 2.54 mm (² / ₁₀ " lead spacing, anode marking: projection at package bottom

Grenzwerte**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebs- und Lagertemperatur Operating and storage temperature range	$T_{op}; T_{stg}$	- 40 ... + 125	°C
Löttemperatur (Lötstelle 2 mm vom Gehäuse entfernt bei Lötzeit $t \leq 3$ s) Soldering temperature in 2 mm distance from case bottom ($t \leq 3$ s)	T_S	230	°C
Sperrspannung Reverse voltage	V_R	50	V
Verlustleistung, $T_A = 25$ °C Total power dissipation	P_{tot}	250	mW

Kennwerte ($T_A = 25$ °C, Normlicht A, $T = 2856$ K)**Characteristics** ($T_A = 25$ °C, standard light A, $T = 2856$ K)

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Fotoempfindlichkeit, $V_R = 5$ V Spectral sensitivity	S	10 (≥ 5.5)	nA/lx
Wellenlänge der max. Fotoempfindlichkeit Wavelength of max. sensitivity	$\lambda_{S\ max}$	850	nm
Spektraler Bereich der Fotoempfindlichkeit $S = 10\%$ von S_{max} Spectral range of sensitivity $S = 10\%$ of S_{max}	λ	350 ... 1100	nm
Bestrahlungsempfindliche Fläche Radiant sensitive area	A	1.00	mm ²
Abmessung der bestrahlungsempfindlichen Fläche Dimensions of radiant sensitive area	$L \times B$ $L \times W$	1×1	mm
Abstand Chipoberfläche zu Gehäuseoberfläche Distance chip front to case surface	H	2.25 ... 2.55	mm
Halbwinkel Half angle	φ	± 40	Grad deg.
Dunkelstrom Dark current BPX 65: $V_R = 20$ V	I_R	1 (≤ 5)	nA

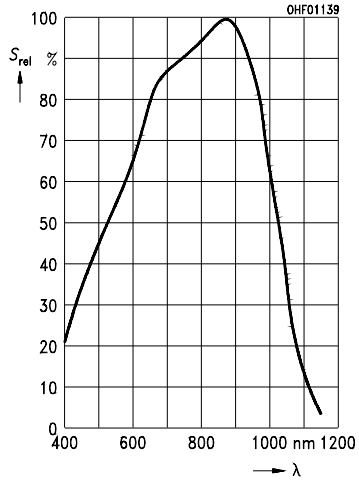
Kennwerte ($T_A = 25\text{ °C}$, Normlicht A, $T = 2856\text{ K}$)

Characteristics ($T_A = 25\text{ °C}$, standard light A, $T = 2856\text{ K}$) (cont'd)

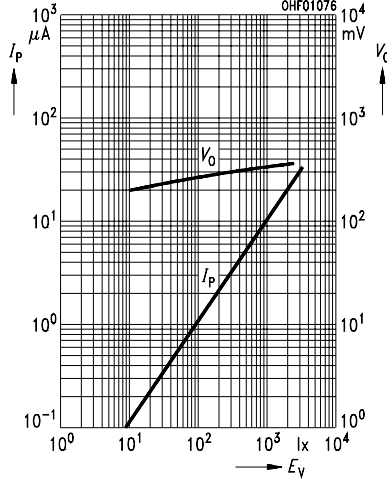
Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Spektrale Fotoempfindlichkeit, $\lambda = 850\text{ nm}$ Spectral sensitivity	S_λ	0.55	A/W
Quantenausbeute, $\lambda = 850\text{ nm}$ Quantum yield	η	0.80	<u>Electrons</u> Photon
Leerlaufspannung, $E_V = 1000\text{ lx}$ Open-circuit voltage	V_L	320 (≥ 270)	mV
Kurzschlußstrom, $E_V = 1000\text{ lx}$ Short-circuit current	I_K	10	μA
Anstiegs und Abfallzeit des Fotostromes Rise and fall time of the photocurrent $R_L = 50\ \Omega$; $V_R = 5\text{ V}$; $\lambda = 850\text{ nm}$; $I_p = 800\ \mu\text{A}$	t_r, t_f	12	ns
Durchlaßspannung, $I_F = 100\text{ mA}$, $E = 0$ Forward voltage	V_F	1.3	V
Kapazität, $V_R = 0\text{ V}$, $f = 1\text{ MHz}$, $E = 0$ Capacitance	C_0	11	pF
Temperaturkoeffizient von V_L Temperature coefficient of V_L	TC_V	-2.6	mV/K
Temperaturkoeffizient von I_K Temperature coefficient of I_K	TC_I	0.2	%/K
Rauschäquivalente Strahlungsleistung Noise equivalent power $V_R = 20\text{ V}$, $\lambda = 850\text{ nm}$	NEP	3.3×10^{-14}	$\frac{\text{W}}{\sqrt{\text{Hz}}}$
Nachweisgrenze, $V_R = 20\text{ V}$, $\lambda = 850\text{ nm}$ Detection limit	D^*	3.1×10^{12}	$\frac{\text{cm} \times \sqrt{\text{Hz}}}{\text{W}}$

Relative Spectral Sensitivity

$S_{rel} = f(\lambda)$

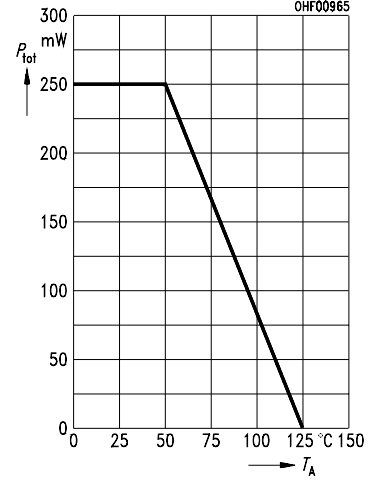


**Photocurrent $I_P = f(E_V)$, $V_R = 5\text{ V}$
Open-Circuit-Voltage $V_O = f(E_V)$**



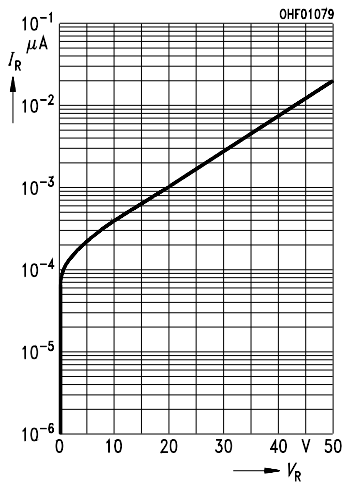
Total Power Dissipation

$P_{tot} = f(T_A)$



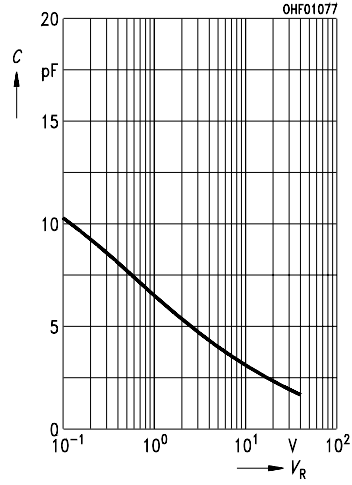
Dark Current

$I_R = f(V_R), E = 0$



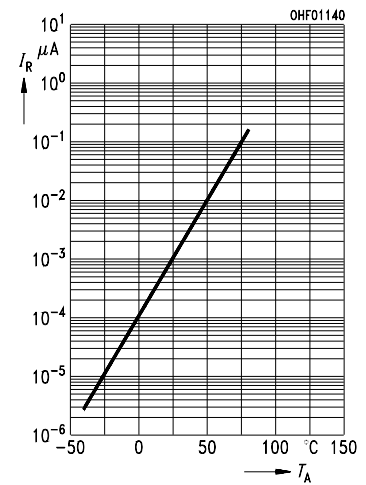
Capacitance

$C = f(V_R), f = 1\text{ MHz}, E = 0$



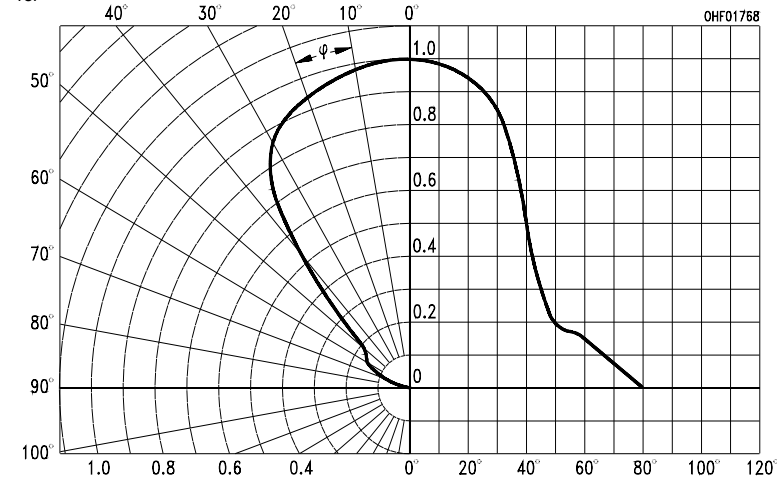
Dark Current

$I_R = f(T_A), V_R = 20\text{ V}, E = 0$

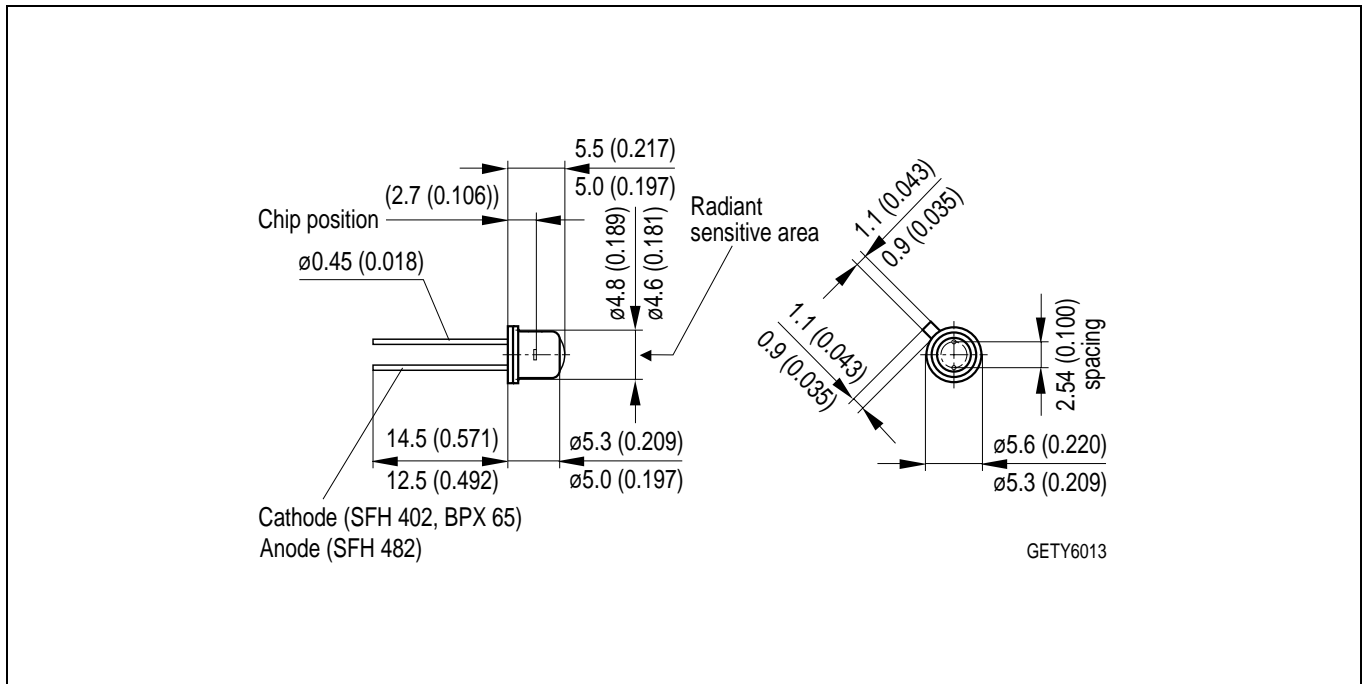


Directional Characteristics

$S_{rel} = f(\phi)$



**Maßzeichnung
Package Outlines**



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

Published by OSRAM Opto Semiconductors GmbH & Co. OHG
Wernerwerkstrasse 2, D-93049 Regensburg
© All Rights Reserved.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances. For information on the types in question please contact our Sales Organization.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Components used in life-support devices or systems must be expressly authorized for such purpose! Critical components ¹, may only be used in life-support devices or systems ² with the express written approval of OSRAM OS.

¹ A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or effectiveness of that device or system.

² Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health of the user may be endangered.

SUNSTAR实业集团是集研发、生产、工程、销售、代理经销、技术咨询、信息服务等为一体的高科技企业，是专业高科技电子产品生产厂家，是具有10多年历史的专业电子元器件供应商，是中国最早和最大的仓储式连锁规模经营大型综合电子零部件代理分销商之一，是一家专业代理和分销世界各大品牌IC芯片和电子元器件的连锁经营综合性国际公司。在香港、北京、深圳、上海、西安、成都等全国主要电子市场设有直属分公司和产品展示展销窗口门市部专卖店及代理分销商，已在全国范围内建成强大统一的供货和代理分销网络。我们专业代理经销、开发生产电子元器件、集成电路、传感器、微波光电元器件、工控机/DOC/DOM电子盘、专用电路、单片机开发、MCU/DSP/ARM/FPGA软件硬件、二极管、三极管、模块等，是您可靠的一站式现货配套供应商、方案提供商、部件功能模块开发配套商。专业以现代信息产业（计算机、通讯及传感器）三大支柱之一的传感器为主营业务，专业经营各类传感器的代理、销售生产、网络信息、科技图书资料及配套产品设计、工程开发。我们的专业网站——**中国传感器科技信息网（全球传感器数据库）www.SENSOR-IC.COM** 服务于全球高科技生产商及贸易商，为企业科技产品开发提供技术交流平台。欢迎各厂商互通有无、交换信息、交换链接、发布寻求代理信息。欢迎国外高科技传感器、变送器、执行器、自动控制产品厂商介绍产品到**中国**，共同开拓市场。本网站是关于各种传感器-变送器-仪器仪表及工业自动化大型专业网站，深入到工业控制、系统工程计 测计量、自动化、安防报警、消费电子等众多领域，把最新的传感器-变送器-仪器仪表买卖信息，最新技术供求，最新采购商，行业动态，发展方向，最新的技术应用和市场资讯及时的传递给广大科技开发、科学研究、产品设计人员。本网站已成功为石油、化工、电力、医药、生物、航空、航天、国防、能源、冶金、电子、工业、农业、交通、汽车、矿山、煤炭、纺织、信息、通信、IT、安防、环保、印刷、科研、气象、仪器仪表等领域从事科学研究、产品设计、开发、生产制造的科技人员、管理人员、和采购人员提供满意服务。 **我公司专业生产、代理、经销、销售各种传感器、变送器、敏感元器件、开关、执行器、仪器仪表、自动化控制系统：专门从事设计、生产、销售各种传感器、变送器、各种测控仪表、热工仪表、现场控制器、计算机控制系统、数据采集系统、各类环境监控系统、专用控制系统应用软件以及嵌入式系统开发及应用等工作。如热敏电阻、压敏电阻、温度传感器、温度变送器、湿度传感器、湿度变送器、气体传感器、气体变送器、压力传感器、压力变送、称重传感器、物（液）位传感器、物（液）位变送器、流量传感器、流量变送器、电流（压）传感器、溶氧传感器、霍尔传感器、图像传感器、超声波传感器、位移传感器、速度传感器、加速度传感器、扭距传感器、红外传感器、紫外传感器、火焰传感器、激光传感器、振动传感器、轴角传感器、光电传感器、接近传感器、簧管传感器、继电器传感器、微型电泵、磁敏（阻）传感器、压力开关、接近开关、光电开关、色标传感器、光纤传感器、齿轮测速传感器、时间继电器、计数器、计米器、温控仪、固态继电器、调压模块、电磁铁、电压表、电流表等特殊传感器。同时承接传感器应用电路、产品设计和自动化工程项目。**

欢迎索取免费详细资料、设计指南和光盘；产品凡多，未能尽录，欢迎来电查询。

更多产品请看本公司产品专用销售网站：

中国传感器科技信息网：<http://www.sensor-ic.com/>工控安防网：<http://www.pc-ps.net/>

电子元器件网：<http://www.sunstare.com/>微波光电产品网：[HTTP://www.rfoe.net/](http://www.rfoe.net/)

消费电子产品网：<http://www.icasic.com/>军工产品网：<http://www.junpinic.com/>

实业科技产品网：<http://www.sunstars.cn/>传感器销售热线：

电话：0755-83607652 83376489 83376549 83370250 83370251

传真：0755-83376182 (0) 13902971329 MSN: SUNS8888@hotmail.com

邮编：518033 E-mail: szss20@163.com QQ: 195847376

技术支持：0755-83394033 13501568376